

PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

April 27, 2006

Applicant(s) : Chisato HOSHINO  
For : THERMAL CONDUCTIVE SILICONE COMPOSITION

Serial No. : 10/567 587                      Group: Unknown  
Confirmation No.: Unknown  
Filed : Unknown                      Examiner: Unknown  
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Atty. Docket No.: 3400.P1429US

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the provisions of Rules 1.97(b)(2) and 1.98, enclosed herewith is Form PTO-1449 and the references cited thereon. Copies of cited U.S. references are not submitted in accordance with 37 CFR 1.98(a).

Further consideration is respectfully solicited.

Respectfully submitted,

TFC/jas

  
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Encl: Form PTO-1449 and references cited thereon  
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INFORMATION DISCLOSURE CITATION	Applicant: Chisato HOSHINO
	Ser.No.: 10/567 587      Filed: Unknown
	Conf. No.: Unknown      Atty. Docket No.: 3400.P1429US
	Group: Unknown      Date: April 27, 2006

## U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No.	Document Number - Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant
	AA	US 5 246 703	09-21-1993	Durfee
	AB	US 5 420 189	05-30-1995	Kishita et al
	AC	US 6 005 131	12-21-1999	Jentsch et al
	AD	US 6 025 435	02-15-2000	Yamakawa et al

## FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No.	Country Code - Document Number - Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Trans.
	AH	JP 51 55870	05-17-1976	Shinetsu Chem Ind. Co. Ltd.	Abstract
	AI	JP 64 49959	02-27-1989	Tokico Ltd.	Abstract
	AJ	JP 2 97559	04-10-1990	Toshiba Silicone Co. Ltd.	Abstract
	AK	JP 3 47841	2-28-1991	Toray Dow Corning Silicone Co. Ltd.	Abstract
	AL	JP 2623380	12-11-1992	Shin Etsu Chem Co. Ltd.	Abstract
	AM	JP 5 255359	10-05-1993	Dow Corning Corporation	US Equiv
	AN	JP 6-271773	09-27-1994		US Equiv
	AO	JP 6-329916	11-29-1994	Shin Etsu Chem Co. Ltd.	Abstract
	AP	JP 8-92371	04-09-1996	Shin Etsu Chem Co. Ltd.	Abstract
	AQ	JP 8-325457	12-10-1996		US Equiv
	AR	JP 9-25411	01-28-1997		
	AS	JP 9-208591	08-12-1997	Bayer Aktiengesells Chafft	US Equiv
	AT	JP 2000-1616	01-07-2000	Shin Etsu Chem Co. Ltd.	Abstract
	AU	JP 2000-256558	09-19-2000	Shin Etsu Chem Co. Ltd.	Abstract
	AV	JP 2000-327917	11-28-2000	Fuji Kobunshi Kogyo KK	Abstract
	AW	JP 2001-348483	12-18-2001	Dow Corning Toray Silicone Co. Ltd.	Abstract
	AX	JP 2003-213133	07-30-2003	Shin Etsu Chem Co. Ltd.	Abstract
	AY	JP 2004-122664	04-22-2004	Shin Etsu Chem Co. Ltd.	Abstract

## NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No.	(Include Author, Title, Date, Pages, Etc.)
	AZ	
EXAMINER SIGNATURE		DATE CONSIDERED

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